

N-Channel 60V, 1.9Ω Typ. Power MOSFET

Description

Features

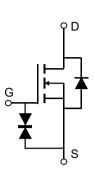
• 60V, 0.3A

$$R_{DS(ON)}$$
 Typ = 1.9 Ω @ V_{GS} = 4.5 V

$$R_{DS(ON)}$$
 Typ = 2.3 Ω @ V_{GS} = 2.5 V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free

• ESD Protected: 1.5KV





G 1

Marking and Pin Assignment

Application

- Load Switch
- PWM Application
- Power Management

Package Marking and Ordering Information

| Device | Marking | Package | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|------------|---------|---------|---------|-----------|------------|------------------|
| CRMLTU138K | U138K | SOT-23 | TAPING | 7" | 3000 | 120000 |

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

| Symbol | Parameter | | Value | Units |
|-----------------|--|------------------------|------------|-------|
| V_{DS} | Drain-to-Source Voltage | | 60 | V |
| V _{GS} | Gate-to-Source Voltage | | ±20 | V |
| | Continuous Drain Current | T _A = 25°C | 0.3 | А |
| I _D | Continuous Drain Current | T _A = 100°C | 0.2 | А |
| I _{DM} | Pulsed Drain Current (1) | | 1.2 | А |
| P_{D} | Power Dissipation | T _A = 25°C | 0.45 | W |
| $R_{	heta JA}$ | Thermal Resistance, Junction to Ambient ⁽²⁾ | | 278 | °C/W |
| T_J,T_STG | Junction & Storage Temperature Range | | -55 to 150 | °C |

CRMLTU138K

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------------|--|---|------------|------|------|------|
| Off Char | acteristics | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 60 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 60V, V_{GS} = 0V$ | - | - | 1.0 | μА |
| I _{GSS} | Gate-Body Leakage Current | $V_{DS} = 0V, V_{GS} = \pm 20V$ | - | - | ±10 | μΑ |
| On Char | acteristics | | | | G | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 0.5 | 0.85 | 1.2 | V |
| R _{DS(ON)} § | Static Drain-Source ON-Resistance ⁽³⁾ | $V_{GS} = 4.5V, I_D = 0.3A$ | - | 1.9 | 2.5 | Ω |
| | | $V_{GS} = 2.5V, I_D = 0.2A$ | - | 2.3 | 4.5 | Ω |
| Dynamic | Characteristics | | | | | |
| C _{iss} | Input Capacitance | | -(| 22 | - | pF |
| C_{oss} | Output Capacitance | $V_{GS} = 0V$, $V_{DS} = 25V$, f = 1MHz | X - \ | 3 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | 1 - 11VII 12 | | 2 | - | pF |
| Q_g | Total Gate Charge | | U - | 1.8 | - | nC |
| Q_gs | Gate Source Charge | $V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 0.3A$ | - | 0.4 | - | nC |
| Q_{gd} | Gate Drain("Miller") Charge | V _{DS} = 10V, I _D = 0.0A | - | 0.7 | - | nC |
| Switchin | g Characteristics | | | | | |
| t _{d(on)} | Turn-On DelayTime | .() | - | 2 | - | ns |
| t _r | Turn-On Rise Time | V _{GS} = 10V, V _{DD} = 10V | - | 16 | - | ns |
| $t_{\text{d(off)}}$ | Turn-Off DelayTime | $I_{D} = 0.2A, R_{GEN} = 10\Omega$ | - | 7 | - | ns |
| t_f | Turn-Off Fall Time | | - | 19 | - | ns |
| Orain-So | urce Diode Characteristics and I | Max Ratings | | | | |
| Is | Maximum Continuous Drain to Source Diode Forward Current | | | - | 0.3 | Α |
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 1.2 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS} = 0V, I_{S} = 0.3A$ | | _ | 1.2 | V |

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} $R_{\text{\tiny BJA}}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

Typical Performance Characteristics

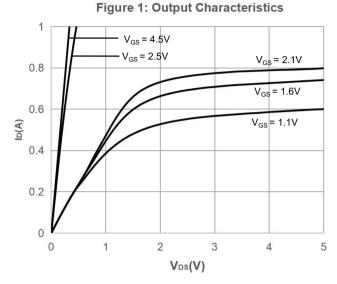


Figure 3: On-resistance vs. Drain Current

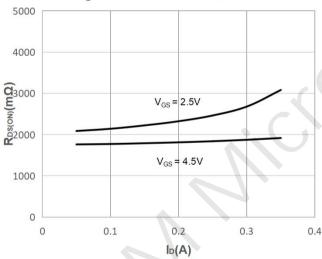


Figure 5: Gate Charge Characteristics

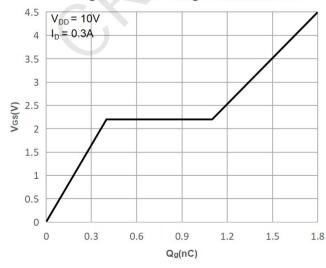


Figure 2: Typical Transfer Characteristics

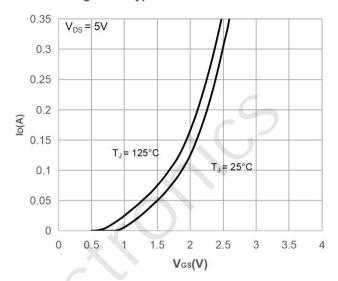


Figure 4: Body Diode Characteristics

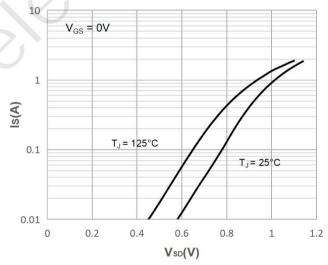
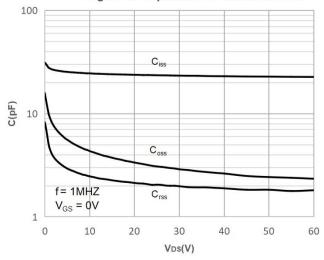


Figure 6: Capacitance Characteristics





Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

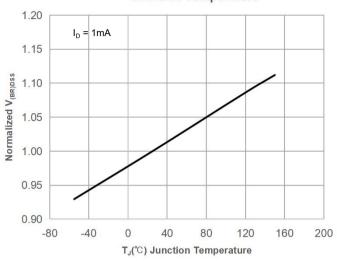


Figure 9: Maximum Safe Operating Area

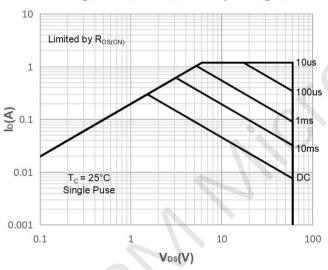


Figure 11: Normalized Maximum Transient

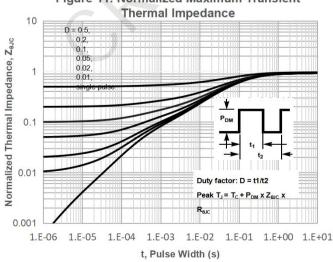


Figure 8: Normalized on Resistance vs. Junction Temperature

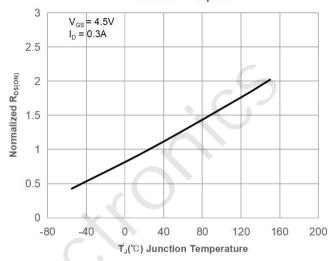


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

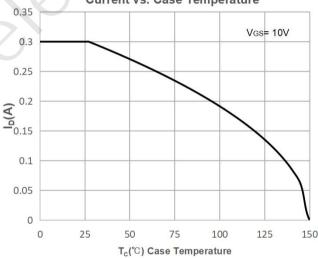
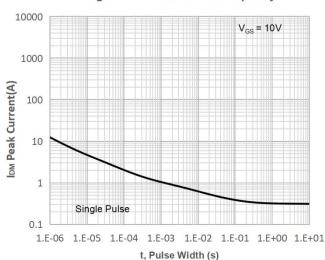


Figure 12: Peak Current Capacity





Test Circuit

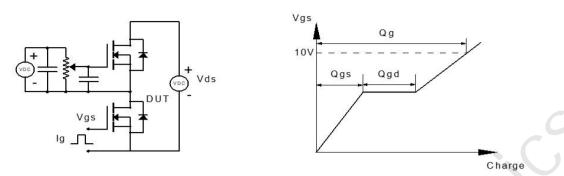


Figure 1: Gate Charge Test Circuit & Waveform

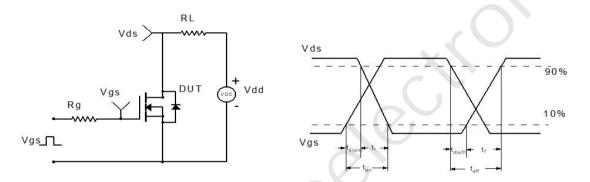


Figure 2: Resistive Switching Test Circuit & Waveform

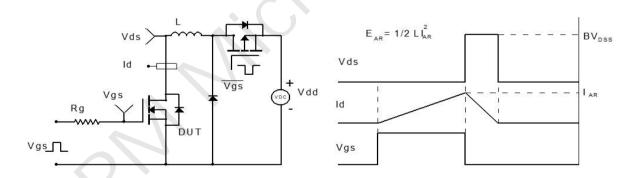


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

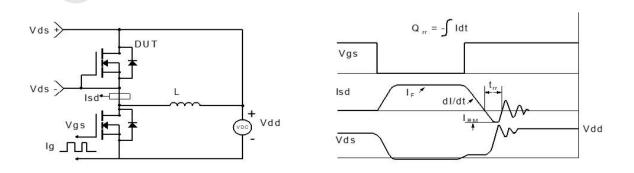
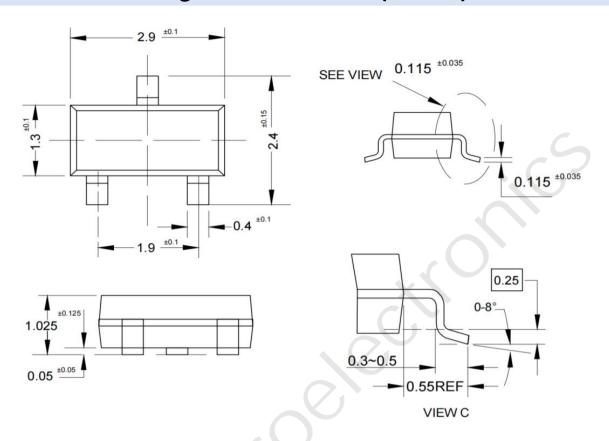


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(SOT-23)



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